Cyberbond

U3337

TECHNICAL DATA SHEET



Cyberlite U3337 is a medium-to-high viscosity, UV-curable adhesive designed for bonding a wide variety of plastics in a multitude of configurations. It is strong, flexible and well-suited to bonding dissimilar substrates.

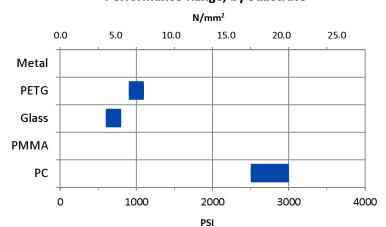
Physical Propertie	s - Monomer (Uncured)				
Base Compound	Modified Acrylate				
Appearance	Light Straw Liquid				
Viscosity	1000 +/- 150 cps				
Specific Gravity	1.1 g/cc				
Flash Point	> 95°C				
Shelf Life	6 months				
Storage Condition	8°C to 21°C in darkness				
RoHS-Compliant	Yes				
Physical Properties - Polymer (Cured)					
Setting Time*	< 6 seconds				
Full Cure Time	24 hours				
Appearance	Colorless solid				
Tack-Free Surface?	Yes				
Elongation	175%				
Shore Hardness	- (Shore A) 70 (Shore D)				
Optimal Wavelength	300 to 420 nm				

*Polymerized	@	395nm	@	50mW/cm ²	

Performance of Cured Adhesive						
Substrate	N/mm²			PSI		
Metal	n/r	to	n/r	n/r	to	n/r
PETG	6.2	to	7.6	900	to	1100
Glass	4.1	to	5.5	600	to	800
PMMA	n/r	to	n/r	n/r	to	n/r
PC	17.2	to	20.7	2500	to	3000

^{*} n/r = not recommended for use on this substrate

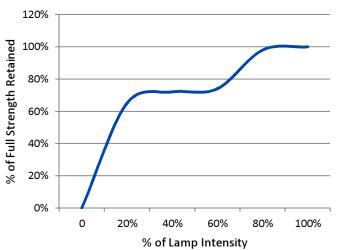
Performance Range, by Substrate



Specifications and Approvals

None

% Strength Retained @ Given Dosage



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Solvent Resistance		
Solvent	Example	Resistance
Alcohol	Ethanol, Methanol	+++
Ester (aromatic)	Ethylacetate	
Ketone (aromatic)	Acetone, Benzophenone	
Aliphatic hydrocarbon (alkanes)	Petrol, Heptanes, Hexane	++-
Aromatic hydrocarbons	Benzyl, Toluol, Xylol	++-
Halogenated hydrocarbons	Methylenchloride, Chloroform, Chlorobenzol	
Weak aqueous acid	Nitrite, muriatic acid, sulphuric acid, phosphoric acid	+ + + (if concentrated)
Weak aqueous base	sodium hydroxide solution, caustic potash	+ + + (if concentrated)

General Instructions

Surfaces to be bonded should be clean and dry. Dispense a drop or drops to one surface only. Apply only enough to leave a thin film layer after compression. Press parts together and expose to UV dose when ready. An adequate bond should develop rapidly, depending on UV dose efficacy, and maximum strength is attained in 24 hours. Wipe off excess adhesive from the top of the container and recap. Cyberlite products, if left uncapped or exposed to sunlight, may deteriorate or cure prematurely.

For safe handling information on this product, consult the Material Safety Data Sheet (MSDS)



Authorized Distributor

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Curing Performance

Photoinitiation initiates the curing process. Handling strength is reached in a short time, and will vary based on UV dose efficacy, environmental conditions, bond line gap, and other factors. Product will continue to cure for at least 24 hours before full strength and solvent resistance is developed.

Storage

Products should be stored unopened in a cool, dry place out of direct sunlight. Products should be kept at room temperature away from direct light. Protect from extreme heat or cold, do not refrigerate.

Note

The data contained herein are furnished for information only and are believed to be reliable. Cyberbond cannot assume responsibility for the results obtained by others over whose method Cyberbond does not control. It is the user's responsibility to determine suitability for the product or of any production methods mentioned herein and to adopt such precautions as may be advisable for the protection of property and of persons against any hazards that may be involved in the handling and use thereof. In light of the foregoing, Cyberbond specifically disclaims all warranties of merchantability or fitness for a particular purpose arising from sale or use of Cyberbond products. Cyberbond specifically disclaims any liability for consequential or incidental damages of any kind, including loss of profits. The discussion herein of various processes or compositions is not to be interpreted as representation that they are free from domination of patents owned by others or as a license under any Cyberbond patents which may cover such processes or compositions. We recommend that each prospective user test the proposed application to determine its suitability for the purpose intended prior to incorporating any product or application in its manufacturing process using the data as a guide.

